

TR BC368;TO92;tranzystor; NPN;1A;20V;0.8W;Pbf

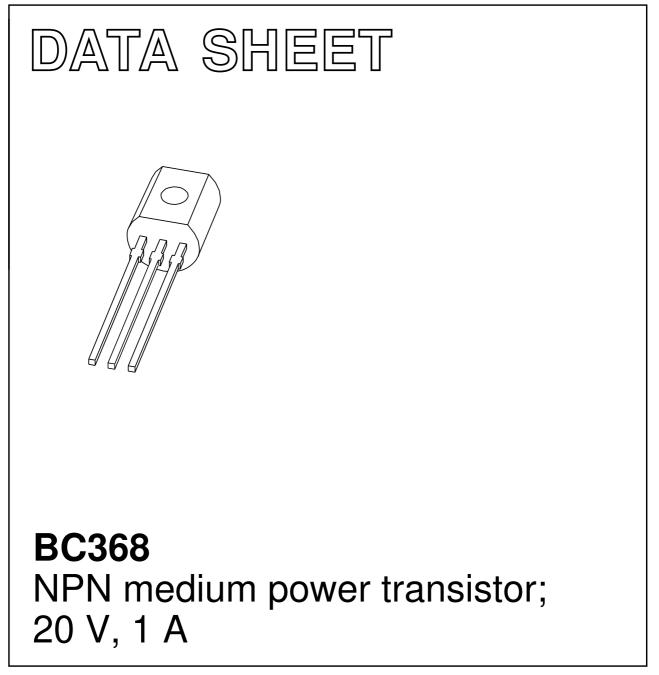


Dane techniczne:

Nazwa: BC368 Typ tranzystora: bipolarny Kierunek przewodnictwa: NPN Prąd kolektora: 1A Napięcie kolektor-emiter: 20V Moc: 0.8W Obudowa: TO92 Montaż: przewlekany (THT)

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DISCRETE SEMICONDUCTORS



Product specification Supersedes data of 2003 Dec 01 2004 Nov 05



NPN medium power transistor; 20 V, 1 A

FEATURES

• High current.

APPLICATIONS

- Linear voltage regulators
- Low side switch
- Supply line switch for negative voltages
- MOSFET driver
- Audio (pre-) amplifier.

QUICK REFERENCE DATA

SYMBOL	PARAMETER	MIN.	MAX.	UNIT
V _{CEO}	collector-emitter voltage	-	20	V
I _C	collector current (DC)	-	1	А
I _{CM}	peak collector current	-	2	А
h _{FE}	DC current gain	85	375	-

DESCRIPTION

NPN medium power transistor (see "Simplified outline, symbol and pinning" for package details).

PRODUCT OVERVIEW

TYPE NUMBER	P/	ACKAGE	MARKING CODE	PNP COMPLEMENT	
I TPE NUMBER	PHILIPS	EIAJ			
BC368	SOT54	SC-43A	C368	BC369	

SIMPLIFIED OUTLINE, SYMBOL AND PINNING

TYPE NUMBER		PINNING		
I TPE NUMBER	NUMBER SIMPLIFIED OUTLINE AND SYMBOL		DESCRIPTION	
BC368		1	base	
		2	collector	
		3	emitter	

ORDERING INFORMATION

		PACKAGE			
	NAME	NAME DESCRIPTION VERSION			
BC368	SC-43A	SC-43A plastic single-ended (through hole) package; 3 leads SOT			

BC368

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BC368

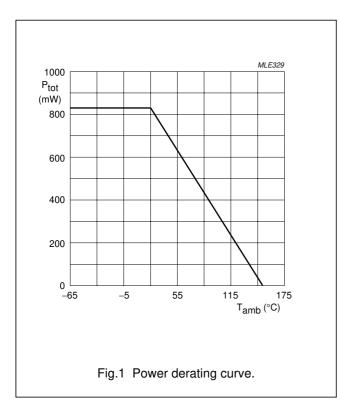
LIMITING VALUES

In accordance with the Absolute Maximum Rating System (IEC 60134).

SYMBOL	PARAMETER	CONDITIONS	MIN.	MAX.	UNIT
V _{CBO}	collector-base voltage	open emitter	-	32	V
V _{CEO}	collector-emitter voltage	open base	_	20	V
V _{EBO}	emitter-base voltage	open collector	_	5	V
I _C	output current (DC)		-	1	mA
I _{CM}	peak collector current		-	2	mA
I _{BM}	peak collector current		_	200	mA
P _{tot}	total power dissipation $T_{amb} \le 25 \text{ °C}$; notes 1 and 2		-	0.83	W
T _{stg}	storage temperature		-65	+150	°C
Tj	junction temperature		-	150	°C
T _{amb}	ambient temperature		-65	+150	°C

Notes

- 1. Refer to SOT54 (SC-43A) standard mounting conditions.
- 2. Device mounted on an FR4 printed-circuit board, single-sided copper, tin-plated footprint.



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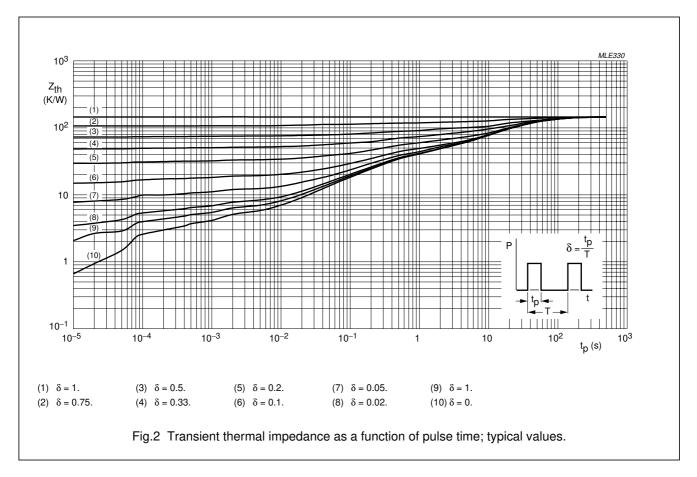
THERMAL CHARACTERISTICS

SYMBOL	PARAMETER	CONDITIONS	VALUE	UNIT	
R _{th(j-a)}	thermal resistance from junction to ambient	$T_{amb} \le 25 \ ^{\circ}C$; notes 1 and 2	150	K/W	

Notes

1. Refer to SOT54 (SC-43A) standard mounting conditions.

2. Device mounted on an FR4 printed-circuit board, single-sided copper, tin-plated footprint.



BC368

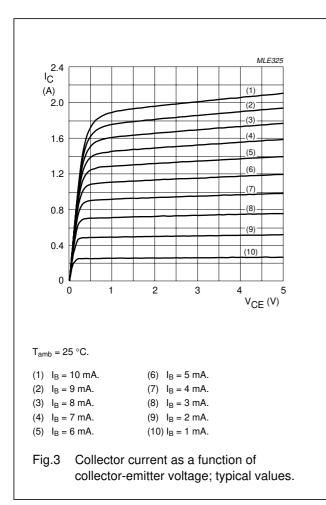
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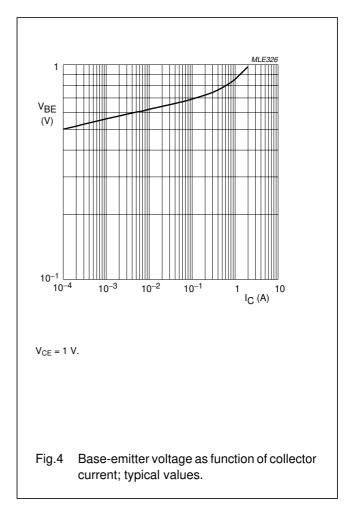
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CHARACTERISTICS

 T_{amb} = 25 °C unless otherwise specified.

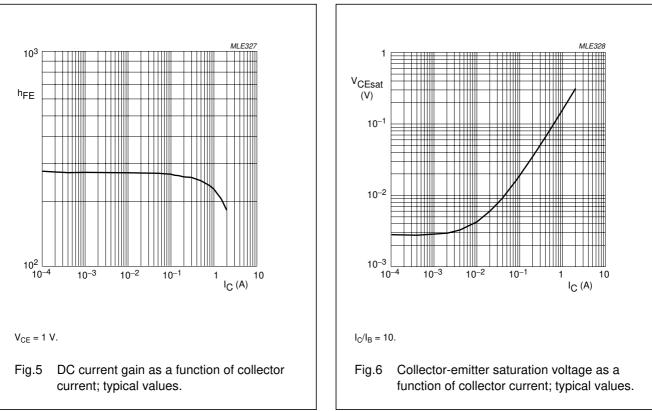
SYMBOL	PARAMETER	CONDITIONS	MIN.	TYP.	MAX.	UNIT
I _{CBO}	collector-base cut-off current	V _{CB} = 25 V; I _E = 0 A	_	-	100	nA
		$V_{CB} = 25 \text{ V}; I_E = 0 \text{ A};$ $T_{amb} = 150 \text{ °C}$	-	-	10	μA
I _{EBO}	emitter-base cut-off current	$V_{EB} = 5 V; I_{C} = 0 A$	-	-	100	nA
h _{FE}	DC current gain	V _{CE} = 10 V; I _C = 5 mA	50	-	-	
		V _{CE} = 1 V; I _C = 500 mA	85	-	375	
		$V_{CE} = 1 V; I_{C} = 1 mA$	60	-	-	
V _{CEsat}	collector-emitter saturation voltage	I _C = 1 A; I _B = 100 mA	-	-	500	mV
V _{BE}	base-emitter voltage	V _{CE} = 10 V; I _C = 5 mA	-	-	700	mV
		$V_{CE} = 1 V; I_C = 1 A$	-	-	1	V
C _c	collector capacitance	$\label{eq:V_CB} \begin{split} V_{CB} &= 10 \text{ V}; \text{ I}_{E} = \text{ i}_{e} = 0 \text{ A};\\ \text{ f} &= 1 \text{ MHz} \end{split}$	-	22	-	pF
f _T	transition frequency	$V_{CE} = 5 \text{ V}; I_{C} = 50 \text{ mA};$ f = 100 MHz	40	170	-	MHz





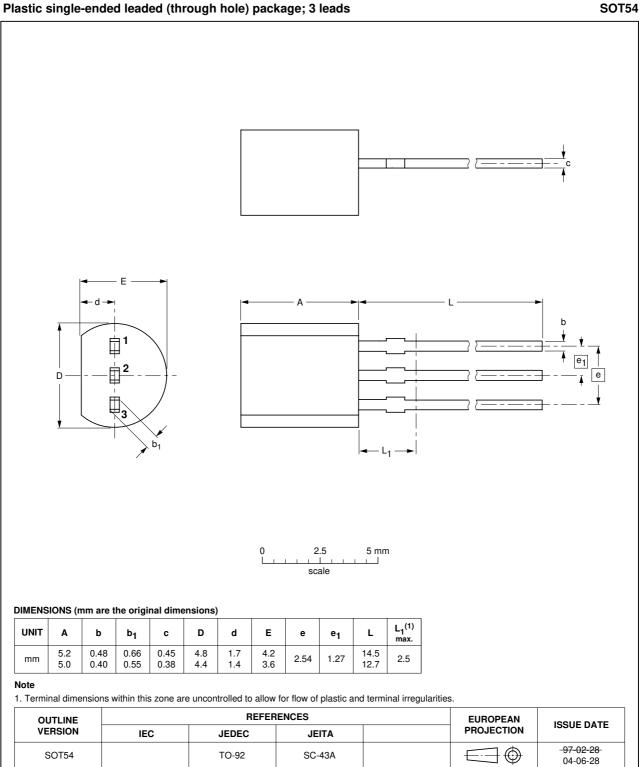
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PACKAGE OUTLINE



2004 Nov 05

BC368

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BC368

DATA SHEET STATUS

LEVEL	DATA SHEET STATUS ⁽¹⁾	PRODUCT STATUS ⁽²⁾⁽³⁾	DEFINITION
1	Objective data	Development	This data sheet contains data from the objective specification for product development. Philips Semiconductors reserves the right to change the specification in any manner without notice.
11	Preliminary data	Qualification	This data sheet contains data from the preliminary specification. Supplementary data will be published at a later date. Philips Semiconductors reserves the right to change the specification without notice, in order to improve the design and supply the best possible product.
	Product data	Production	This data sheet contains data from the product specification. Philips Semiconductors reserves the right to make changes at any time in order to improve the design, manufacturing and supply. Relevant changes will be communicated via a Customer Product/Process Change Notification (CPCN).

Notes

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- 3. For data sheets describing multiple type numbers, the highest-level product status determines the data sheet status.

DEFINITIONS

Short-form specification — The data in a short-form specification is extracted from a full data sheet with the same type number and title. For detailed information see the relevant data sheet or data handbook.

Limiting values definition — Limiting values given are in accordance with the Absolute Maximum Rating System (IEC 60134). Stress above one or more of the limiting values may cause permanent damage to the device. These are stress ratings only and operation of the device at these or at any other conditions above those given in the Characteristics sections of the specification is not implied. Exposure to limiting values for extended periods may affect device reliability.

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Printed in The Netherlands

R75/05/pp9

Date of release: 2004 Nov 05

Document order number: 9397 750 13564

SCA76

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